

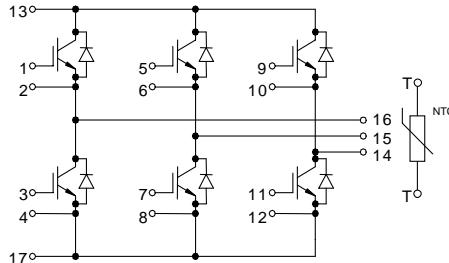
IGBT Modules

Sixpack

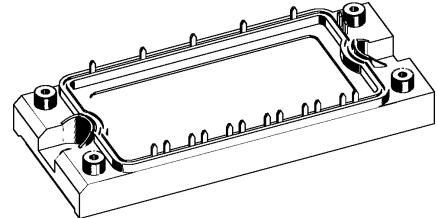
Short Circuit SOA Capability
Square RBSOA

Preliminary Data

Type:	NTC - Option:
MWI 50-12 A7	without NTC
MWI 50-12 A7T	with NTC



I_{C25} = 85 A
 V_{CES} = 1200 V
 $V_{CE(sat)\text{ typ.}}$ = 2.2 V



IGBTs

Symbol	Conditions	Maximum Ratings		
V_{CES}	$T_{VJ} = 25^\circ\text{C}$ to 150°C	1200		V
V_{GES}		± 20		V
I_{C25}	$T_C = 25^\circ\text{C}$	85		A
I_{C80}	$T_C = 80^\circ\text{C}$	60		A
RBSOA	$V_{GE} = \pm 15 \text{ V}$; $R_G = 22 \Omega$; $T_{VJ} = 125^\circ\text{C}$ Clamped inductive load; $L = 100 \mu\text{H}$	$I_{CM} = 100$ $V_{CEK} \leq V_{CES}$		A
t_{sc} (SCSOA)	$V_{CE} = V_{CES}$; $V_{GE} = \pm 15 \text{ V}$; $R_G = 22 \Omega$; $T_{VJ} = 125^\circ\text{C}$ non-repetitive	10	μs	
P_{tot}	$T_C = 25^\circ\text{C}$	350		W

Symbol	Conditions	Characteristic Values		
		($T_{VJ} = 25^\circ\text{C}$, unless otherwise specified)	min.	typ.
$V_{CE(sat)}$	$I_C = 50 \text{ A}$; $V_{GE} = 15 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.2 2.5	2.7	V

$V_{GE(\text{th})}$	$I_C = 2 \text{ mA}$; $V_{GE} = V_{CE}$	4.5		6.5	V
I_{CES}	$V_{CE} = V_{CES}$; $V_{GE} = 0 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		3	4	mA
I_{GES}	$V_{CE} = 0 \text{ V}$; $V_{GE} = \pm 20 \text{ V}$		200	nA	
$t_{d(on)}$ t_i $t_{d(off)}$ t_f E_{on} E_{off}	Inductive load, $T_{VJ} = 125^\circ\text{C}$ $V_{CE} = 600 \text{ V}$; $I_C = 50 \text{ A}$ $V_{GE} = \pm 15 \text{ V}$; $R_G = 22 \Omega$	100 70 500 70 7.6 5.6		ns ns ns ns mJ mJ	
C_{ies} Q_{Gon}	$V_{CE} = 25 \text{ V}$; $V_{GE} = 0 \text{ V}$; $f = 1 \text{ MHz}$ $V_{CE} = 600 \text{ V}$; $V_{GE} = 15 \text{ V}$; $I_C = 50 \text{ A}$	3300 230		pF nC	
R_{thJC}	(per IGBT)		0.35	K/W	

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Diodes

Symbol	Conditions	Maximum Ratings		
I_{F25}	$T_C = 25^\circ C$	110	A	
I_{F80}	$T_C = 80^\circ C$	70	A	

Symbol Conditions

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V_F	$I_F = 50 A; V_{GE} = 0 V; T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	2.2 1.6	2.6 1.8	V
t_{rr}	$\left. \begin{array}{l} I_F = 50 A; dI_F/dt = -400 A/\mu s; T_{VJ} = 125^\circ C \\ V_R = 600 V; V_{GE} = 0 V \end{array} \right\}$	40 200		A ns
R_{thJC}	(per diode)		0.61	K/W

Temperature Sensor NTC (MWI ... A7T version only)

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
R_{25}	$T = 25^\circ C$	4.75	5.0	5.25 kΩ
$B_{25/50}$			3375	K

Module

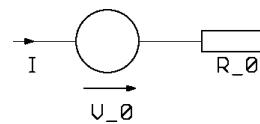
Symbol	Conditions	Maximum Ratings		
		min.	typ.	max.
T_{VJ}		-40...+150		°C
T_{stg}		-40...+125		°C
V_{ISOL}	$I_{ISOL} \leq 1 mA; 50/60 Hz$	2500		V~
M_d	Mounting torque (M5)	2.7 - 3.3		Nm

Symbol Conditions

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
$R_{pin-chip}$		5		mΩ
d_s	Creepage distance on surface	6		mm
d_A	Strike distance in air	6		mm
R_{thCH}	with heatsink compound	0.02		K/W
Weight		180		g

Equivalent Circuits for Simulation

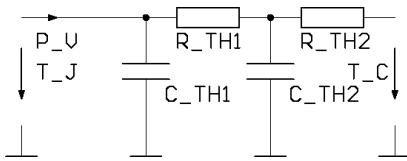
Conduction



IGBT (typ. at $V_{GE} = 15 V; T_J = 125^\circ C$)
 $V_\theta = 1.5 V; R_\theta = 20.7 m\Omega$

Free Wheeling Diode (typ. at $T_J = 125^\circ C$)
 $V_\theta = 1.3 V; R_\theta = 11.3 m\Omega$

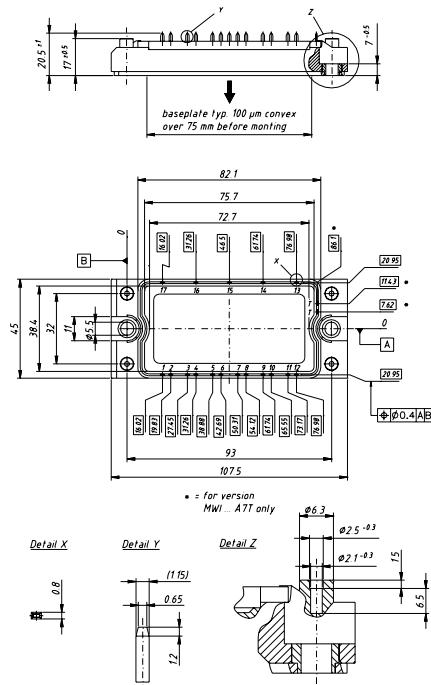
Thermal Response



IGBT (typ.)
 $C_{th1} = 0.22 J/K; R_{th1} = 0.26 K/W$
 $C_{th2} = 1.74 J/K; R_{th2} = 0.09 K/W$

Free Wheeling Diode (typ.)
 $C_{th1} = 0.16 J/K; R_{th1} = 0.483 K/W$
 $C_{th2} = 1.37 J/K; R_{th2} = 0.127 K/W$

Dimensions in mm (1 mm = 0.0394")



Higher magnification see outlines.pdf

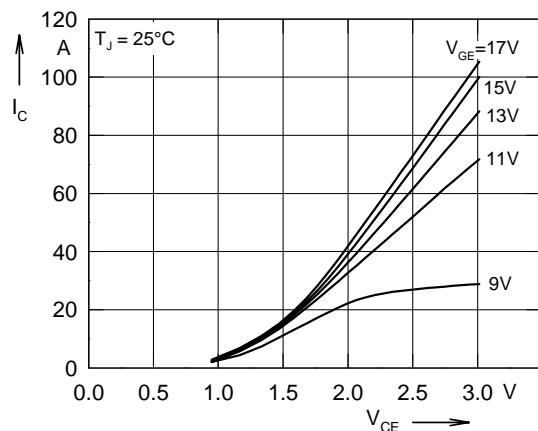


Fig. 1 Typ. output characteristics

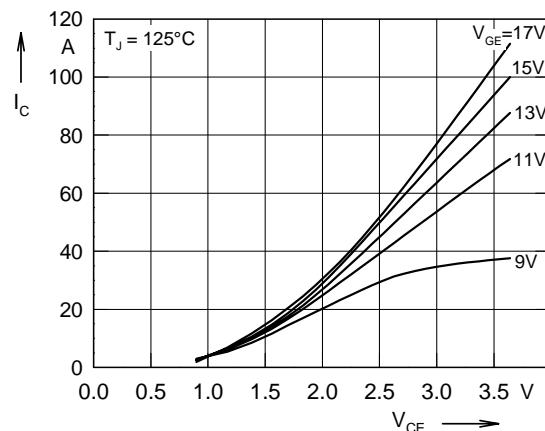


Fig. 2 Typ. output characteristics

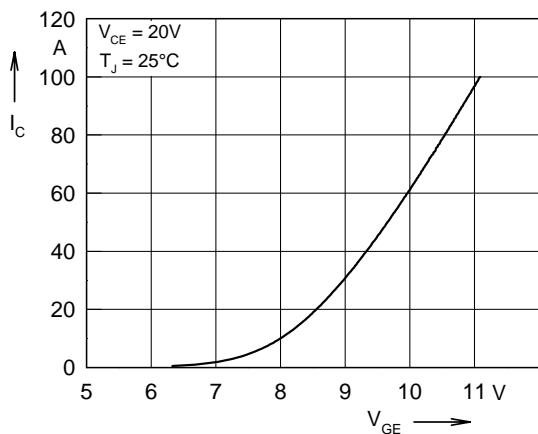


Fig. 3 Typ. transfer characteristics

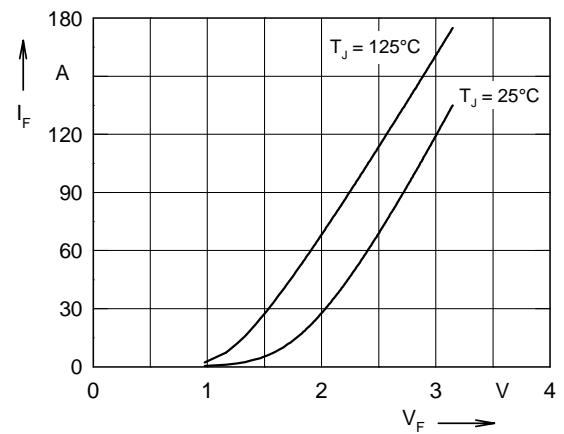


Fig. 4 Typ. forward characteristics of free wheeling diode

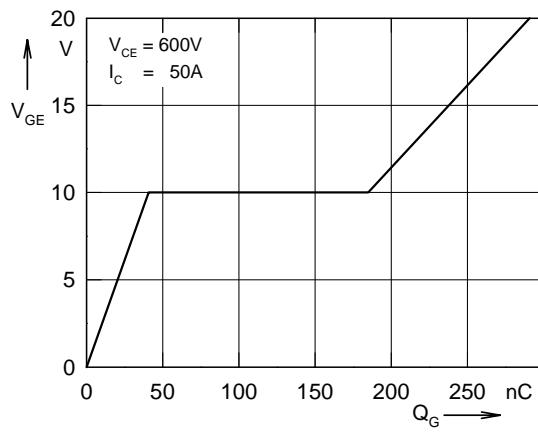


Fig. 5 Typ. turn on gate charge

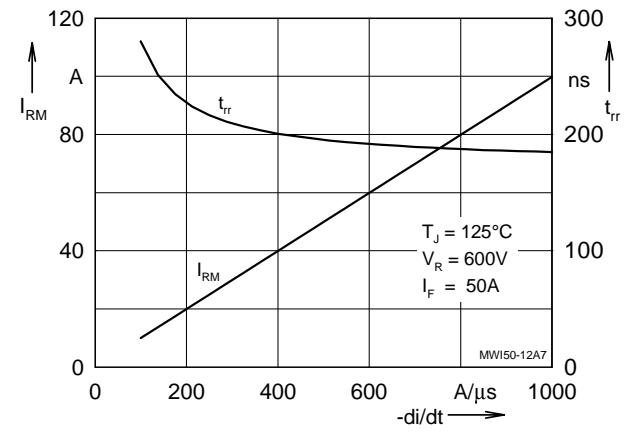


Fig. 6 Typ. turn off characteristics of free wheeling diode

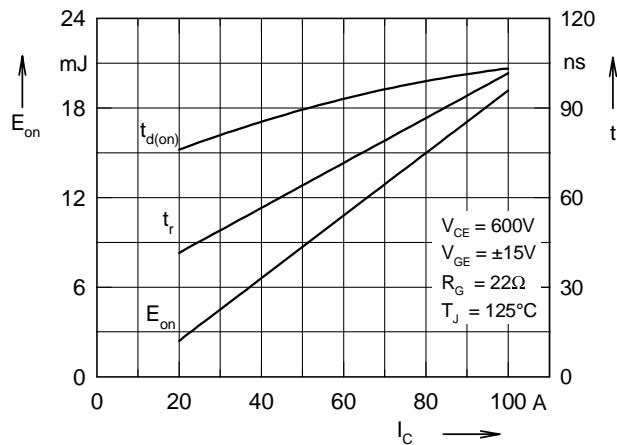


Fig. 7 Typ. turn on energy and switching times versus collector current

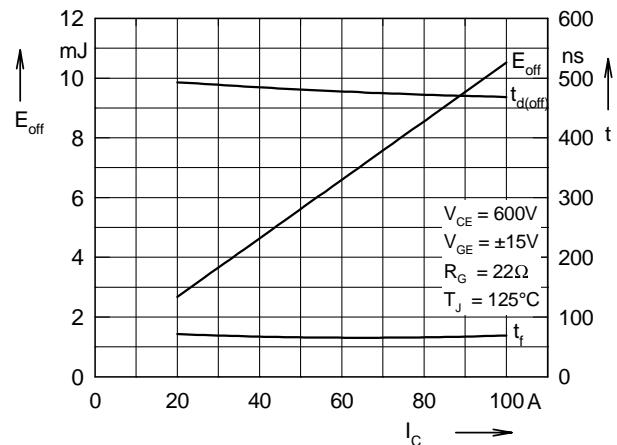


Fig. 8 Typ. turn off energy and switching times versus collector current

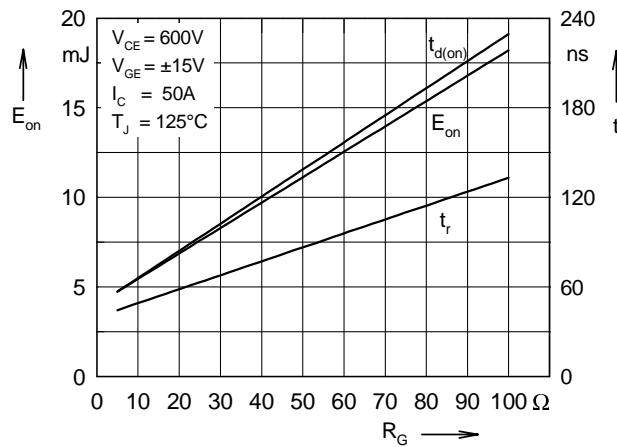


Fig. 9 Typ. turn on energy and switching times versus gate resistor

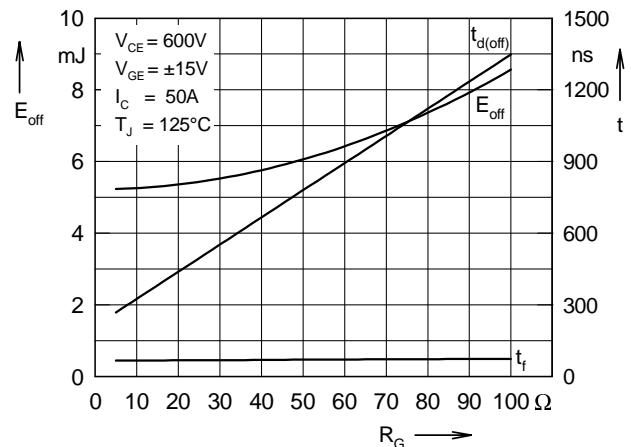


Fig. 10 Typ. turn off energy and switching times versus gate resistor

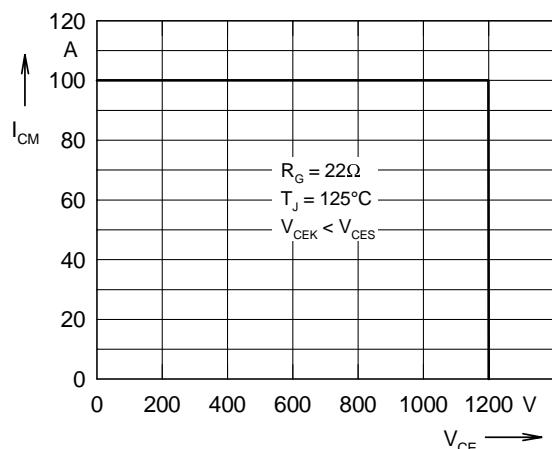


Fig. 11 Reverse biased safe operating area RBSOA

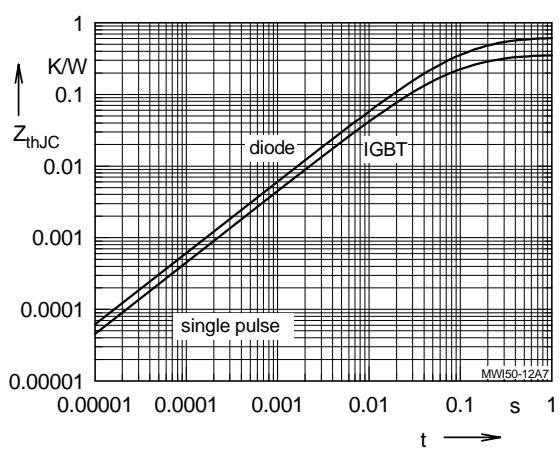


Fig. 12 Typ. transient thermal impedance